

iF packaging award at interpack 2011

The iF packaging award, which was introduced for the first time at the 2008 interpack exhibition by iF International Forum Design GmbH, will again be presented at the 2011 event. The award, which previously attracted 148 entrants from 17 countries, celebrates innovative concepts in all areas of packaging including packaging materials, wrapping, graphics and packaging machinery. The next interpack takes place at its customary Düsseldorf venue 12-18 May 2011 and it is possible to submit entries for the iF packaging award from May 2010. www.messe-duesseldorf.com